Operational Amplifiers, Non-Compensated, Single

A general purpose operational amplifier that allows the user to choose the compensation capacitor best suited to his needs. With proper compensation, summing amplifier slew rates to $10~V/\mu s$ can be obtained.

Features

- Low Input Offset Current: 20 nA Maximum Over Temperature Range
- External Frequency Compensation for Flexibility
- Class AB Output Provides Excellent Linearity
- Output Short Circuit Protection
- Guaranteed Drift Characteristics
- Pb-Free Packages are Available

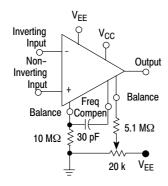


Figure 1. Standard Compensation and Offset Balancing Circuit

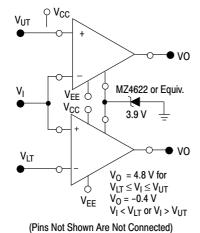


Figure 2. Double-Ended Limit Detector



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MARKING DIAGRAMS

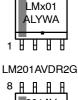


PDIP-8 N SUFFIX CASE 626





SOIC-8 D SUFFIX CASE 751



8 <u>A A A A</u>

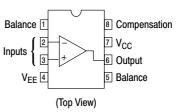


c = 2 or 3

A = Assembly Location

WL, L = Wafer Lot YY, Y = Year WW, W = Work Week G = Pb-Free Package ■ Pb-Free Package

PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

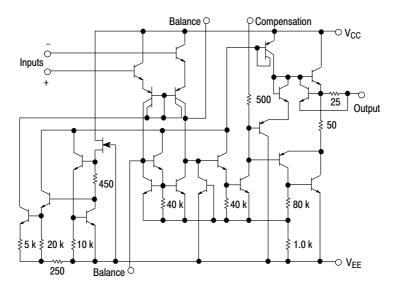


Figure 3. Representative Circuit Schematic

ORDERING INFORMATION

Device	Package	Shipping [†]
LM301ADG	SOIC-8 (Pb-Free)	98 Units/Rail
LM301ADR2G	SOIC-8 (Pb-Free)	2500 Tape & Reel
LM301AN	PDIP-8	50 Units/Rail
LM301ANG	PDIP-8 (Pb-Free)	50 Units/Rail
LM201ADG	SOIC-8 (Pb-Free)	98 Units/Rail
LM201ADR2G	SOIC-8 (Pb-Free)	2500 Tape & Reel
LM201AN	PDIP-8	50 Units/Rail
LM201ANG	PDIP-8 (Pb-Free)	50 Units/Rail
LM201AVDR2G	SOIC-8 (Pb-Free)	2500 Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

		Value			
Rating	Symbol	LM201A	LM201AV	LM301A	Unit
Power Supply Voltage	$V_{CC,}V_{EE}$	±22	±22	±18	Vdc
Input Differential Voltage	V_{ID}	~	±30	>	V
Input Common Mode Range (Note 1)	V _{ICR}	←	±15	>	V
Output Short Circuit Duration	t _{SC}	~	Continuous	→	
Power Dissipation (Package Limitation)	P_{D}				
Plastic Dual-In-Line Package		625	625	625	mW
Derate above T _A = +25°C		5.0	5.0	5.0	mW/°C
Operating Ambient Temperature Range	T _A	-25 to +85	-40 to +105	0 to +70	°C
Storage Temperature Range	T _{stg}	←	65 to +150 -	→	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ELECTRICAL CHARACTERISTICS ($T_A = +25^{\circ}C$, unless otherwise noted.) Unless otherwise specified, these specifications apply for supply voltages from $\pm 5.0 \text{ V}$ to $\pm 20 \text{ V}$ for the LM201A and LM201AV, and from $\pm 5.0 \text{ V}$ to $\pm 15 \text{ V}$ for the LM301A.

		LM201A / LM201AV			LM301A			
Characteristic	Symbol	Min	Тур	Max	Min	Тур	Max	Unit
Input Offset Voltage ($R_S \le 50 \text{ k}\Omega$)	V _{IO}	-	0.7	2.0	-	2.0	7.5	mV
Input Offset Current	I _{IO}	-	1.5	10	-	3.0	50	nA
Input Bias Current	I _{IB}	-	30	75	-	70	250	nA
Input Resistance	r _i	1.5	4.0	-	0.5	2.0	-	МΩ
Supply Current $V_{CC}/V_{EE} = \pm 20 \text{ V}$ $V_{CC}/V_{EE} = \pm 15 \text{ V}$	I _{CC} ,I _{EE}	- -	1.8 -	3.0 -	- -	- 1.8	- 3.0	mA
Large Signal Voltage Gain $(V_{CC}/V_{EE} = \pm 15 \text{ V}, V_O = \pm 10 \text{ V}, R_L > 2.0 \text{ k}\Omega)$	A _V	50	160	-	25	160	-	V/mV

The following specifications apply over the operating temperature range.

Input Offset Voltage ($R_S \le 50 \text{ k}\Omega$)	V_{IO}	_	_	3.0	-	_	10	mV
Input Offset Current	I _{IO}	-	_	20	-	-	70	nA
Avg Temperature Coefficient of Input Offset Voltage (Note 2) $T_A(\text{min}) \leq T_A \leq T_A \text{ (max)}$	$\Delta V_{IO}/\Delta T$	-	3.0	15	-	6.0	30	μV/°C
Avg Temperature Coefficient of Input Offset Current (Note 2) $+25^{\circ}C \leq T_{A} \leq T_{A} \text{ (max)}$ $T_{A}(\text{min}) \leq T_{A} \leq 25^{\circ}C$	$\Delta I_{IO}/\Delta T$	- -	0.01 0.02	0.1 0.2	1 1	0.01 0.02	0.3 0.6	nA/°C
Input Bias Current	I _{IB}	-	-	100	-	-	300	nA
Large Signal Voltage Gain ($V_{CC}/V_{EE} = \pm 15 \text{ V}, V_O = \pm 10 \text{V}, R_L > 2.0 \text{ k}\Omega$)	A _{VOL}	25	-	-	15	-	-	V/mV
Input Voltage Range V _{CC} /V _{EE} = ±20 V V _{CC} /V _{EE} = ±15 V	V _{ICR}	–15 –	-	+15 -	- -12	-	- +12	V
Common Mode Rejection (R _S \leq 50 k Ω)	CMR	80	96	-	70	90	-	dB
Supply Voltage Rejection ($R_S \le 50 \text{ k}\Omega$)	PSR	80	96	-	70	96	-	dB
Output Voltage Swing $(\text{V}_{CC}/\text{V}_{EE}=\pm 15 \text{ V}, \text{ R}_{L}=\pm 10 \text{ k}\Omega, \text{ R}_{L} > 2.0 \text{ k}\Omega)$	V _O	±12 ±10	±14 ±13	-	±12 ±10	±14 ±13	- -	V
Supply Currents (T _A = T _A (max), V _{CC} /V _{EE} = ±20 V)	I_{CC},I_{EE}	-	1.2	2.5	-	_	_	mA

- 1. For supply voltages less than \pm 15 V, the absolute maximum input voltage is equal to the supply voltage.
- 2. Guaranteed by design.

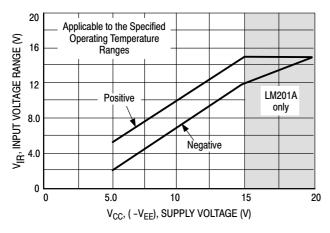


Figure 4. Minimum Input Voltage Range

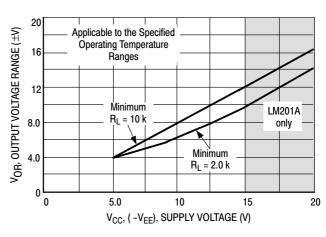


Figure 5. Minimum Output Voltage Swing

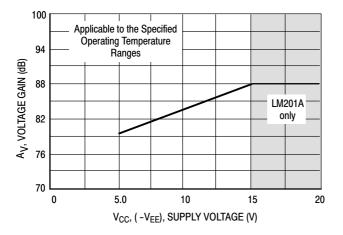


Figure 6. Minimum Voltage Gain

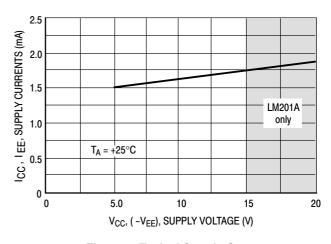


Figure 7. Typical Supply Currents

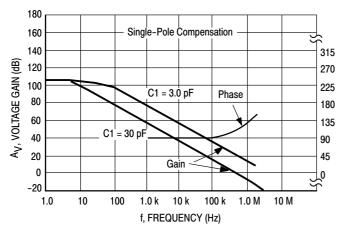


Figure 8. Open Loop Frequency Response

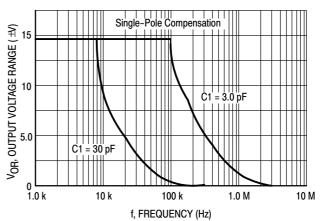


Figure 9. Large Signal Frequency Response

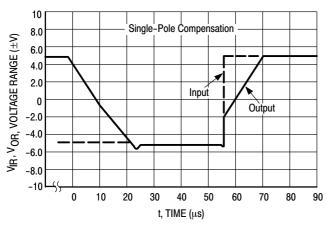


Figure 10. Voltage Follower Pulse Response

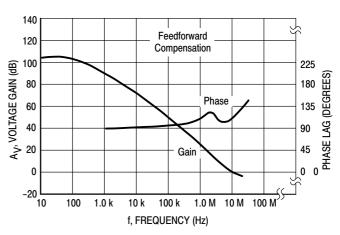


Figure 11. Open Loop Frequency Response

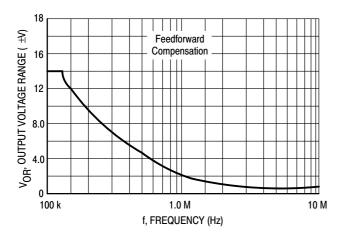


Figure 12. Large Signal Frequency Response

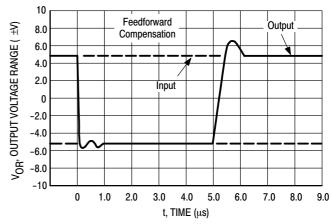


Figure 13. Inverter Pulse Response

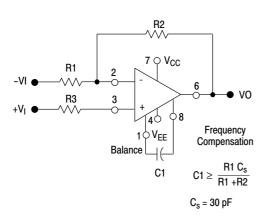


Figure 14. Single-Pole Compensation

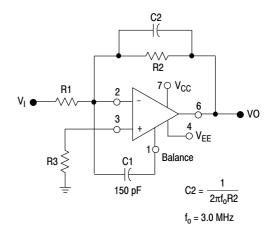
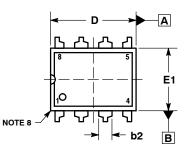


Figure 15. Feedforward Compensation

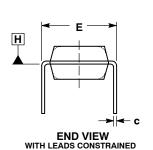


PDIP-8 CASE 626-05 ISSUE P

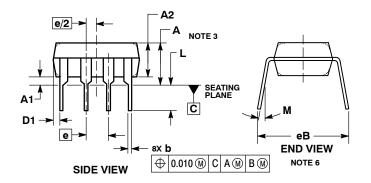
DATE 22 APR 2015



TOP VIEW



NOTE 5



STYLE 1: PIN 1. AC IN 2. DC + IN 3. DC - IN 4. AC IN 5. GROUND 6. OUTPUT

7. AUXILIARY 8. V_{CC}

NOTES

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: INCHES.
 DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACK-
- AGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.
 DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE NOT TO EXCEED 0.10 INCH.
- DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR
- 6. DIMENSION eB IS MEASURED AT THE LEAD TIPS WITH THE
- DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY.
- 8. PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE CORNERS).

	INCHES		MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α		0.210		5.33
A1	0.015		0.38	
A2	0.115	0.195	2.92	4.95
b	0.014	0.022	0.35	0.56
b2	0.060 TYP		1.52	TYP
С	0.008	0.014	0.20	0.36
D	0.355	0.400	9.02	10.16
D1	0.005		0.13	
E	0.300	0.325	7.62	8.26
E1	0.240	0.280	6.10	7.11
е	0.100 BSC		2.54	BSC
eВ		0.430		10.92
L	0.115	0.150	2.92	3.81
М		10°		10°

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code = Assembly Location WL = Wafer Lot

YY = Year WW = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

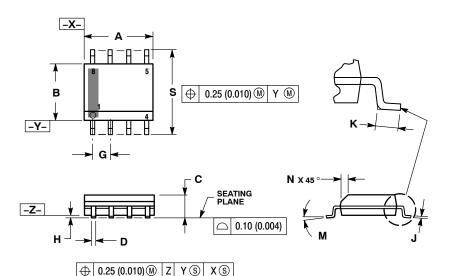
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SOIC-8 NB CASE 751-07 **ISSUE AK**

DATE 16 FEB 2011



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.80	5.00	0.189	0.197
В	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27	1.27 BSC		0 BSC
Н	0.10	0.25	0.004	0.010
7	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
М	0 °	8 °	0 °	8 °
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

SOLDERING FOOTPRINT*



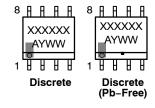
^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code = Assembly Location = Wafer Lot = Year = Work Week

= Pb-Free Package



XXXXXX = Specific Device Code = Assembly Location Α

= Year ww = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

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SOIC-8 NB CASE 751-07 ISSUE AK

DATE 16 FEB 2011

STYLE 1: PIN 1. EMITTER 2. COLLECTOR 3. COLLECTOR 4. EMITTER 5. EMITTER 6. BASE 7. BASE 8. EMITTER	STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 3. COLLECTOR, #2 4. COLLECTOR, #2 5. BASE, #2 6. EMITTER, #2 7. BASE, #1 8. EMITTER, #1	STYLE 3: PIN 1. DRAIN, DIE #1 2. DRAIN, #1 3. DRAIN, #2 4. DRAIN, #2 5. GATE, #2 6. SOURCE, #2 7. GATE, #1 8. SOURCE, #1	
STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN 4. DRAIN 5. GATE 6. GATE 7. SOURCE 8. SOURCE	STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN 4. SOURCE 5. SOURCE 6. GATE 7. GATE 8. SOURCE	STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS 3. THIRD STAGE SOURCE 4. GROUND 5. DRAIN 6. GATE 3 7. SECOND STAGE Vd 8. FIRST STAGE Vd	STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 3. BASE, #2 4. COLLECTOR, #2 5. COLLECTOR, #2 6. EMITTER, #2 7. EMITTER, #1 8. COLLECTOR, #1
STYLE 9: PIN 1. EMITTER, COMMON 2. COLLECTOR, DIE #1 3. COLLECTOR, DIE #2 4. EMITTER, COMMON 5. EMITTER, COMMON 6. BASE, DIE #2 7. BASE, DIE #1 8. EMITTER, COMMON	STYLE 10: PIN 1. GROUND 2. BIAS 1 3. OUTPUT 4. GROUND 5. GROUND 6. BIAS 2 7. INPUT 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3. P-SOURCE	STYLE 11: PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. DRAIN 2 7. DRAIN 1 8. DRAIN 1	STYLE 12: PIN 1. SOURCE 2. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN
STYLE 13: PIN 1. N.C. 2. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN	STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3. P-SOURCE 4. P-GATE 5. P-DRAIN 6. P-DRAIN 7. N-DRAIN 8. N-DRAIN	8. DHAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 3. ANODE 1 4. ANODE 1 5. CATHODE, COMMON 6. CATHODE, COMMON 7. CATHODE, COMMON 8. CATHODE, COMMON	STYLE 16: PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 3. EMITTER, DIE #2 4. BASE, DIE #2 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 7. COLLECTOR, DIE #1 8. COLLECTOR, DIE #1
STYLE 17: PIN 1. VCC 2. V2OUT 3. V1OUT 4. TXE 5. RXE 6. VEE 7. GND 8. ACC	STYLE 18: PIN 1. ANODE 2. ANODE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. CATHODE 8. CATHODE	STYLE 19: PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. MIRROR 1	STYLE 20: PIN 1. SOURCE (N) 2. GATE (N) 3. SOURCE (P) 4. GATE (P) 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN
6. VEE 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3. CATHODE 3 4. CATHODE 4 5. CATHODE 5 6. COMMON ANODE 7. COMMON ANODE 8. CATHODE 6	STYLE 22: PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3. COMMON CATHODE/VCC 4. I/O LINE 3 5. COMMON ANODE/GND 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND	STYLE 23: PIN 1. LINE 1 IN 2. COMMON ANODE/GND 3. COMMON ANODE/GND 4. LINE 2 IN 5. LINE 2 OUT 6. COMMON ANODE/GND 7. COMMON ANODE/GND 8. LINE 1 OUT	0 COLLECTOR/ANODE
STYLE 25: PIN 1. VIN 2. N/C 3. REXT 4. GND 5. IOUT 6. IOUT 7. IOUT 8. IOUT	STYLE 26: PIN 1. GND 2. dv/dt 3. ENABLE 4. ILIMIT 5. SOURCE 6. SOURCE 7. SOURCE 8. VCC	STYLE 27: PIN 1. ILIMIT 2. OVLO 3. UVLO 4. INPUT+ 5. SOURCE 6. SOURCE 7. SOURCE 8. DRAIN	STYLE 28: PIN 1. SW_TO_GND 2. DASIC_OFF 3. DASIC_SW_DET 4. GND 5. V_MON 6. VBULK 7. VBULK 8. VIN
STYLE 29: PIN 1. BASE, DIE #1 2. EMITTER, #1 3. BASE, #2 4. EMITTER, #2 5. COLLECTOR, #2 6. COLLECTOR, #2 7. COLLECTOR, #1 8. COLLECTOR, #1	STYLE 30: PIN 1. DRAIN 1 2. DRAIN 1 3. GATE 2 4. SOURCE 2 5. SOURCE 1/DRAIN 2 6. SOURCE 1/DRAIN 2 7. SOURCE 1/DRAIN 2 8. GATE 1		

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